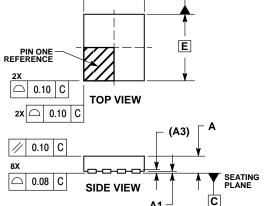


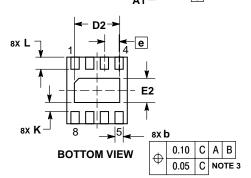


UDFN8 2x2.2, 0.5P CASE 506AV **ISSUE C**

DATE 26 JUN 2013







NOTES

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.
 COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.45	0.50	0.55	
A1	0.00	0.03	0.05	
A3	0.127 REF			
b	0.20	0.25	0.30	
D	2.00 BSC			
D2	1.40	1.50	1.60	
E	2.20 BSC			
E2	0.70	0.80	0.90	
е	0.50 BSC			
K	0.20			
L	0.35	0.40	0.45	

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

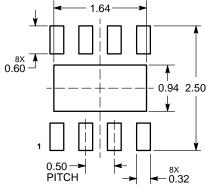
= Date Code

= Pb-Free Device

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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